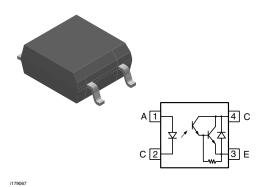


Vishay Semiconductors

Optocoupler, Photodarlington Output, SOP-4 Mini-Flat Package



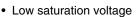
DESCRIPTION

The SFH692AT has a GaAs infrared emitting diode emitter, which is optically coupled to silicon planar photodarlington detector, and is incorporated in a 4 pin 100 mil lead pitch miniflat package. It features a high current transfer ratio, low coupling capacitance, and high isolation voltage.

The coupling devices are designed for signal transmission between two electrically separated circuits. The SFH692AT is available only on tape and reel.

FEATURES

- SOP (small outline package)
- Isolation test voltage, 3750 V_{RMS} (1.0 s)
- High collector emitter breakdown voltage, $V_{CEO} = 300 \text{ V}$



- · Fast switching times
- Temperature stable
- · Low coupling capacitance
- End stackable, 0.100" (2.54 mm) spacing
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

APPLICATIONS

- · High density mounting or space sensitive PCBs
- PLCs
- Telecommunication

AGENCY APPROVALS

- UL1577, file no. E52744 system code U
- DIN EN 60747-5-5 available with option 1
- FIMKO

ORDER INFORMATION	
PART	REMARKS
SFH692AT	CTR > 1000 %, SMD-4

ABSOLUTE MAXIMUM RATINGS (1)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
INPUT						
DC forward current		I _F	50	mA		
Reverse voltage		V _R	6.0	V		
Surge forward current	t _p ≤ 10 μs	I _{FSM}	2.5	Α		
Total power dissipation		P _{diss}	80	mW		
ОИТРИТ						
Collector emitter voltage		V _{CE}	300	V		
Emitter collector voltage		V _{EC}	0.3	V		
Collector current		I _C	50	mA		
Collector current	t _p = 1.0 ms	I _C	150	mA		
Total power dissipation		P _{diss}	200	mW		
COUPLER						
Isolation test voltage between emitter and detector	1.0 s	V _{ISO}	3750	V _{RMS}		
laciation registance	V _{IO} = 500 V, T _{amb} = 25 °C	R _{IO}	≥ 10 ¹²	Ω		
Isolation resistance	V _{IO} = 500 V, T _{amb} = 100 °C	R _{IO}	≥ 10 ¹¹	Ω		

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ABSOLUTE MAXIMUM RATINGS (1)								
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT				
COUPLER	COUPLER							
Storage temperature range		T _{stg}	- 55 to + 150	°C				
Ambient temperature range		T _{amb}	- 55 to + 100	°C				
Junction temperature		Tj	100	°C				
Soldering temperature (2)	max. 10 s dip soldering distance to seating plane ≥ 1.5 mm	T _{sld}	260	°C				

Notes

⁽²⁾ Refer to reflow profile for soldering conditions for surface mounted devices.

ELECTRICAL CHARACTERISTICS									
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT			
INPUT	INPUT								
Forward voltage	I _F = 10 mA	V _F		1.2	1.5	V			
Reverse current	V _R = 6.0 V	I _R		0.01	10	μΑ			
Capacitance	$V_R = 0 \text{ V, f} = 1.0 \text{ MHz}$	Co		14		pF			
Thermal resistance		R _{thja}		750		K/W			
OUTPUT									
Collector emitter leakage current	V _{CE} = 200 V	I _{CEO}			200	nA			
Collector emitter capacitance	V _{CE} = 5.0 V, f = 1.0 MHz	C _{CE}		39		pF			
Thermal resistance		R _{thja}		500		K/W			
COUPLER									
Collector emitter esturation valtage	$I_F = 1.0 \text{ mA}, I_C = 10 \text{ mA}$	V _{CEsat}			1.0	V			
Collector emitter saturation voltage	I _F = 10 mA, I _C = 100 mA	V _{CEsat}	0.3		1.2	V			
Coupling capacitance	$f = 1.0 \text{ MHz}, V_{I-O} = 0 \text{ V}$	C _C	·	6.0		pF			

Note

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Current transfer ratio	$I_F = 1.0 \text{ mA}, V_{CE} = 1.0 \text{ V}$	CTR	1000			%	
Current transfer ratio (collector emitter saturated)	I _F = 10 mA, V _{CE} = 1.0 V	CTR _{CEsat}	500			%	

SWITCHING CHARACTERISTICS							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Rise time	I_C = 10 mA, V_{CC} = 10 V, R_L = 100 Ω	t _r			3.5	μs	
	I_C = 16 mA, V_{CC} = 10 V, R_L = 180 Ω	t _r		1.0		μs	
Fall time	I_C = 10 mA, V_{CC} = 10 V, R_L = 100 Ω	t _f			14.5	μs	
	I_C = 16 mA, V_{CC} = 10 V, R_L = 180 Ω	t _f		20.5		μs	
Turn-on time	I_C = 10 mA, V_{CC} = 10 V, R_L = 100 Ω	t _{on}			4.5	μs	
	I_C = 16 mA, V_{CC} = 10 V, R_L = 180 Ω	t _{on}		1.5		μs	
Turn-off time	I_C = 10 mA, V_{CC} = 10 V, R_L = 100 Ω	t _{off}			29	μs	
rum-on ume	I_C = 16 mA, V_{CC} = 10 V, R_L = 180 Ω	t _{off}		53.5		μs	

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For technical questions, contact: optocoupler.answers@vishay.com

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 $^{^{(1)}}$ $T_{amb} = 25$ °C, unless otherwise specified.

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

 T_{amb} = 25 °C, unless otherwise specified.



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SAFETY AND INSULATION RATINGS								
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Climatic classification (according to IEC 68 part 1)				55/100/21				
Comparative tracking index		CTI	175		399			
V _{IOTM}			6000			V		
V _{IORM}			707			V		
P _{SO}					350	mW		
I _{SI}					150	mA		
T _{SI}					175	°C		
Creepage distance			5			mm		
Clearance distance			5			mm		
Insulation thickness			0.4			mm		

Note

As per IEC 60747-5-2, § 7.4.3.8.1, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

TYPICAL CHARACTERISTICS

T_{amb} = 25 °C, unless otherwise specified

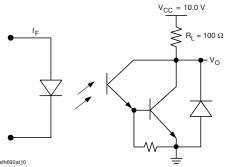
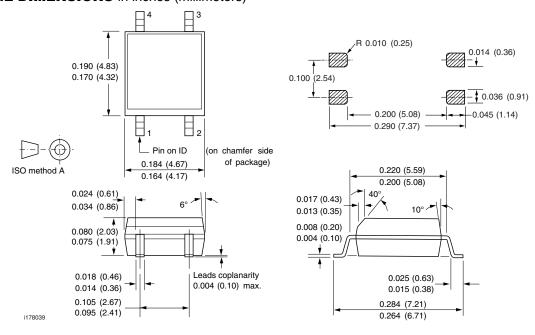


Fig. 1 - Linear Operation (without Saturation)

PACKAGE DIMENSIONS in inches (millimeters)



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SFH692AT

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OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

www.vishay.com 766 For technical questions, contact: optocoupler.answers@vishay.com



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